Doc No. TT4-EA-12659

Revision. 2

MOS FET

FG6943010R

Panasonic

FG6943010R

Silicon N-channel MOSFET(FET1) Silicon P-channel MOSFET(FET2)

For switching

■ Features

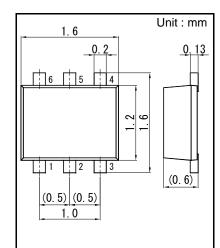
- Low drive voltage: 2.5 V drive • Halogen-free / RoHS compliant
 - (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol V7
- Basic Part Number FJ330301 + FK330301 (Individual)

■ Packaging

Embossed type (Thermo-compression sealing) 8 000 pcs / reel (standard)

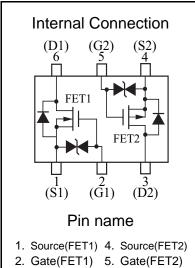
■ Absolute Maximum Ratings Ta = 25 °C

	Parameter	Symbol	Rating	Unit
FET1	Drain-source voltage	VDS	30	V
	Gate-source voltage	VGS	±12	V
	Drain current	ID	100	mA
	Pulse drain current	IDp	200	mA
FET2	Drain-source voltage	VDS	-30	V
	Gate-source voltage	VGS	±12	V
	Drain current	ID	-100	mA
	Pulse drain current	IDp	-200	mA
Overall	Total power dissipation	PT	125	mW
	Channel temperature	Tch	150	°C
	Operating ambient temperature	Topr	-40 to + 85	°C
	Storage temperature	Tstg	-55 to +150	°C



- 1. Source(FET1) 4. Source(FET2)
- 2. Gate(FET1) 5. Gate(FET2)
- 3. Drain(FET2) 6. Drain(FET1)

Panasonic	SSMini6-F3-B		
JEITA	SC-107C		
Code	SOT-666		



- 3. Drain(FET2) 6. Drain(FET1)

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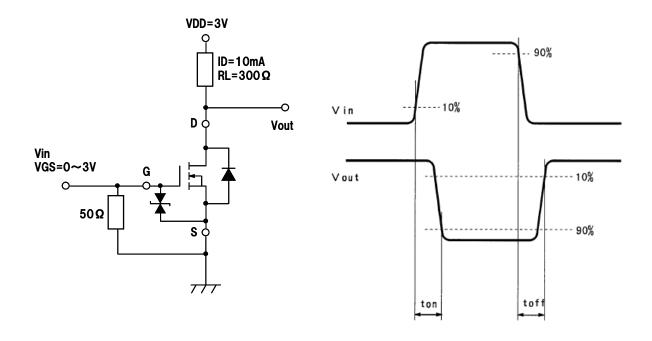
■ Electrical Characteristics Ta = 25 °C ± 3 °C

FET1

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Drain-source breakdown voltage	VDSS	ID = 1 mA, VGS = 0	30			V
Drain-source cutoff current	IDSS	VDS = 30 V, VGS = 0			1.0	μΑ
Gate-source cutoff current	IGSS	VGS = ±10 V, VDS = 0			±10	μΑ
Gate threshold voltage	VTH	ID = 1.0 μA, VDS = 3.0 V	0.5	1.0	1.5	V
Drain-source ON resistance	RDS(on)1	ID = 10 mA, VGS = 2.5 V		3	6	Ω
Dialii-source On resistance	RDS(on)2	ID = 10 mA, VGS = 4.0 V		2	3	Ω
Forward transfer admittance	Yfs	ID = 10 mA, VDS = 3.0 V	20	55		mS
Input capacitance	Ciss			12		pF
Output capacitance	Coss	VDS = 3 V, $VGS = 0$, $f = 1 MHz$		7		pF
Reverse transfer capacitance	Crss			3		pF
T *1	ton	VDD = 3 V, VGS = 0 to 3 V		100		nc
Turn-on time *1		ID = 10 mA	100			ns
Turn-off time *1	toff	VDD = 3 V, VGS = 3 to 0 V		100		20
rum-on time	ion	ID = 10 mA	100			ns

1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

2. *1 FET1 Turn-on and Turn-off test circuit



Established: 2010-06-30 : 2013-10-10 Revised

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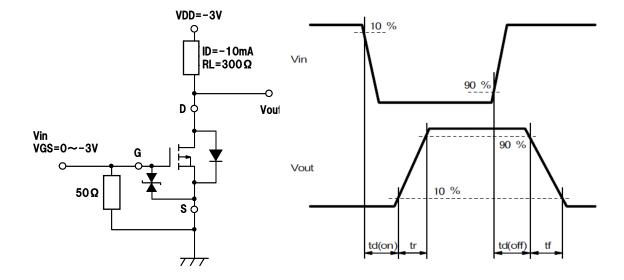
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■ Electrical Characteristics Ta = 25 °C ± 3 °C FET2

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Drain-source breakdown voltage	VDSS	ID = -1mA, $VGS = 0$	-30			V
Drain-source cutoff current	IDSS	VDS = -30 V, VGS = 0			-1.0	μΑ
Gate-source cutoff current	IGSS	VGS = ±10 V, VDS = 0			±10	μΑ
Gate threshold voltage	VTH	ID = -1.0 μA, VDS = -3.0 V	-0.5	-1.0	-1.5	V
Drain-source ON resistance	RDS(on)1	ID = -10 mA, VGS = -2.5 V		7	17	Ω
Diain-source On resistance	RDS(on)2	ID = -10 mA, VGS = -4.0 V		4	7	Ω
Forward transfer admittance	Yfs	ID = -10 mA, VDS = -3.0 V	20	40		mS
Input capacitance	Ciss			12		pF
Output capacitance	Coss	VDS = -3 V, $VGS = 0$, $f = 1 MHz$		7		pF
Reverse transfer capacitance	Crss			3		pF
Turn-on time ^{*1}	ton	VDD = -3 V, VGS = 0 to -3 V, ID = -10 mA		100		ns
Turn-off time ^{*1}	toff	VDD = -3 V, $VGS = -3 to 0 V$, $ID = -10 mA$		100		ns

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

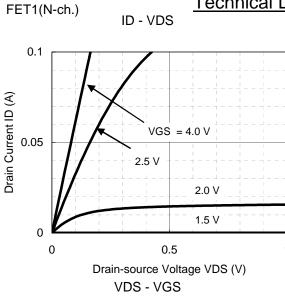
2. *1 FET2 Turn-on and Turn-off test circuit

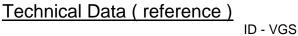


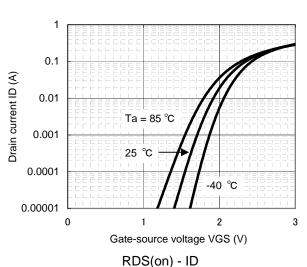
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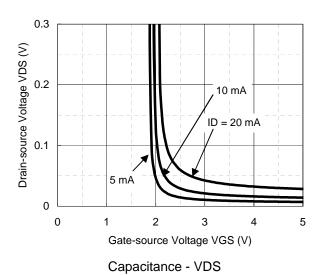
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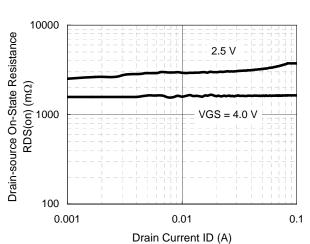
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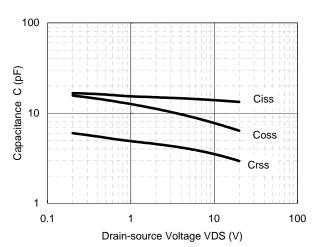










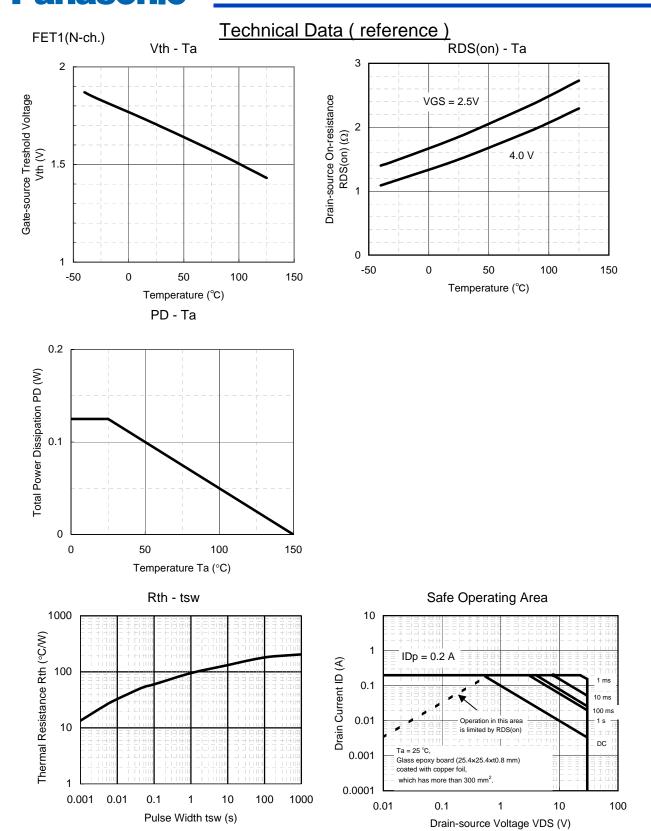


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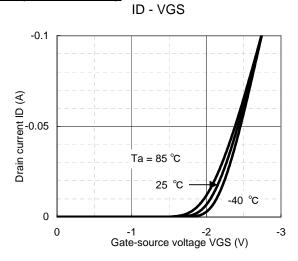


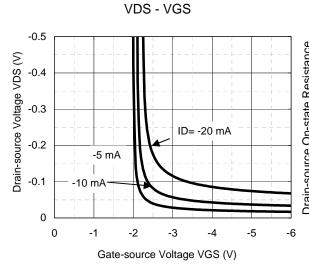
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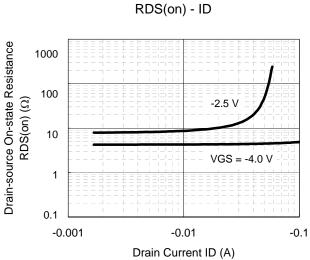
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Technical Data (reference)

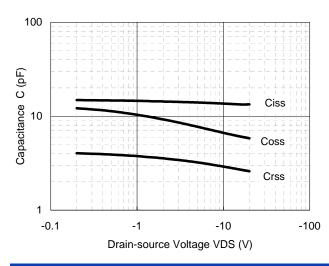
FET2(P-ch.) ID - VDS -0.1 VGS = -4.0 V Drain Current ID (A) -2.5 V -0.05 -1.5 V -2.0 V 0 0 -0.2 -0.4 -0.6 -0.8 -1 Drain-source Voltage VDS (V)







Capacitance - VDS

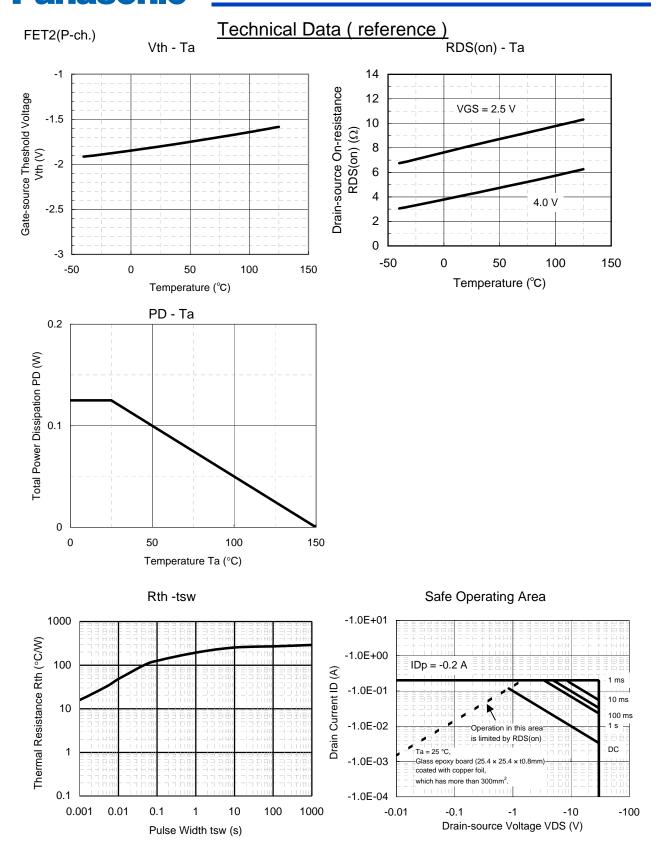


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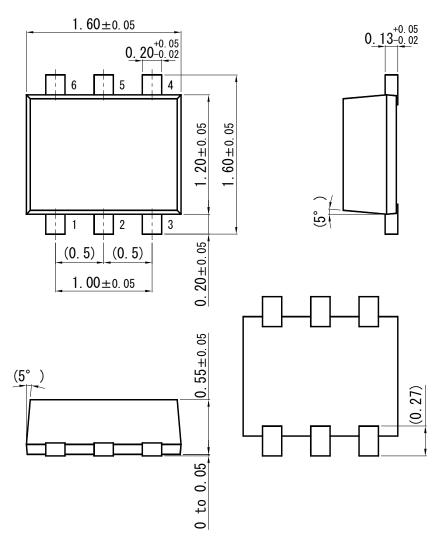


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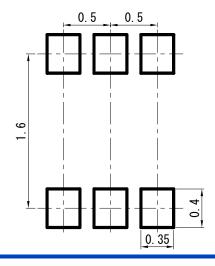
SSMini6-F3-B

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Unit: mm



■ Land Pattern (Reference) (Unit: mm



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